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MEM8205

N-Channel MOSFET MEM8205M6

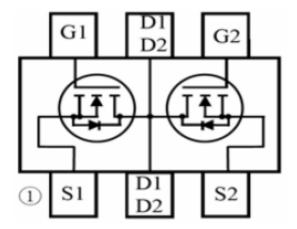
General Description

MEM8205 Series Dual N-channel enhancement mode field-effect transistor ,produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications, and low power dissipation.

Features

- 20V/6A
 - $R_{DS(ON)} = 20m\Omega@V_{GS} = 4.5V, I_D = 4.5A$ $R_{DS(ON)} = 21m\Omega@V_{GS} = 3.85V, I_{D} = 3.5A$ $R_{DS(ON)} = 26m\Omega @ V_{GS} = 2.5V, I_D = 3A$
- High Density Cell Design For Ultra Low On-Resistance
- Surface mount package:SOT23-6L

Pin Configuration



Typical Application

- Battery management
- Power management
- Portable equipment
- Low power DC to DC converter.
- Load switch
- LCD adapter

Absolute Maximum Ratings

Parameter		Symbol	Ratings	Unit	
Drain-Source Voltage		V _{DSS}	20V	V	
Gate-Source Voltage		V _{GSS}	±12	V	
Drain	T 25℃	1	6	٨	
Current	T _A =25℃	I _D	O	A	
Pulsed Drain Current ^{1,2}		I _{DM}	20	А	
Total Power	SOT23-6	Pd	1.25	W	
Dissipation	TSSOP8	ru	1.5	vv	
operating junction temperature		Tj	150	°C	
Storage Temperature Range		T _{stg}	-65/150	°C	



Thermal Characteristics

Thermal Resistance, Junction-to-Ambient ³ RθJA	100	°C/W

Electrical Characteristics MEM8205M6

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit	
	ļ	Static Characteristics	;				
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} =0V, I _D =250uA	20	21.5		V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS},$ $I_D = 250 u A$	0.5	0.66	1	V	
Gate-Body Leakage	I _{GSS}	$V_{DS}=0V$, $V_{GS}=12V$			100	nA	
Cale-Dody Leakage		$V_{DS}=0V$, $V_{GS}=-12V$			-100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =16V V _{GS} =0V		2.5	1000	nA	
Static Drain-Source	R _{DS(ON)}	V_{GS} =4.5V,I _D =6A		20	24	mΩ	
On-Resistance		V _{GS} =3.85V,I _D =5A		21	25	mΩ	
On Resistance		V_{GS} =2.5V,I _D =4A		26	35	mΩ	
Forward Transconductance	g fs	$V_{\text{DS}} = 5V, I_{\text{D}} = 4.5A$		10		S	
Drain-Source Diode Forward Current	I _S				1.7	А	
Source-drain (diode forward) voltage	V_{SD}	V _{GS} =0V,I _D =1.25A		0.8	1.0	V	
	Dy	ynamic Characteristic	cs				
Input Capacitance	Ciss	$V_{DS} = 8 V,$		600		pF	
Output Capacitance	Coss	$V_{GS} = 0 V,$		330			
Reverse Transfer Capacitance	Crss	f = 1 MHz		140			
	Sw	vitching Characteristi	cs				
Turn-On Delay Time	td(on)	$V_{DD} = 10 V,$		8	20		
Rise Time	tr	$R_L = 10 \Omega$		10	25	1	
Turn-Off Delay Time	td(off)	I _D =1 A, V _{GEN} = 4.5 V,		35	70	ns	
Fall-Time	tf	Rg = 6 Ω		30	60		
Total Gate Charge	Qg	V _{DS} = 10 V,		10	15		
Gate-Source Charge	Qgs	$V_{GS} = 4.5 V,$		2.3		nc	
Gate-Drain Charge	Qgd	I _D = 6A		2.9			

 $1\,{\scriptstyle \smallsetminus}\,$ Pulse width limited by Max. junction temperature.

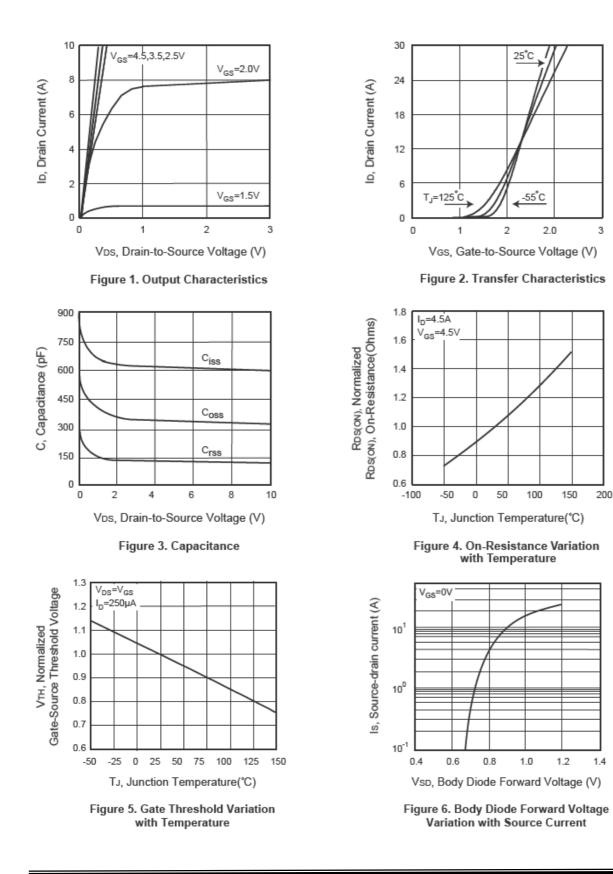
 2_{\times} Pulse width <300us , duty cycle <2%.

3, Surface Mounted on FR4 Board, t < 10 sec.



MEM8205

Typical Performance Characteristics





MEM8205

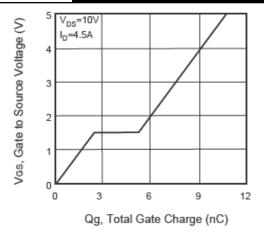


Figure 7. Gate Charge

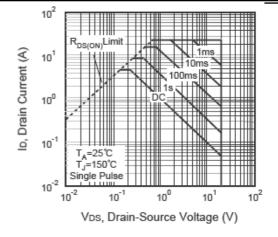
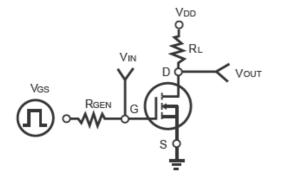


Figure 8. Maximum Safe Operating Area



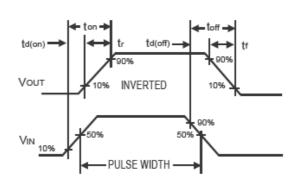


Figure 9. Switching Test Circuit

Figure 10. Switching Waveforms

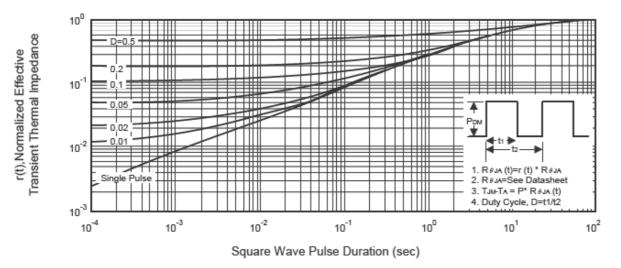
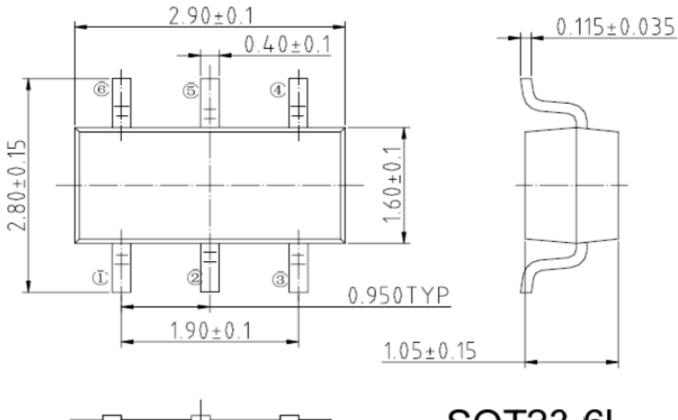
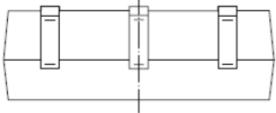


Figure 11. Normalized Thermal Transient Impedance Curve



Package Information





SOT23-6L Unit:mm



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